® 2 Form A **APW212S** APSEMI SOP-8 Load Voltage:60V Load Current:200mA TSCA UPDATE Symbol Rating Units Parameter E534710 V Load Voltage V∟ 60 Load Current IL. А 0.2 2 On-Resistance Ron Ω I/O Breakdown Voltage V/ıo Vrms 2500 (1) 2 input (+) V_{L1}^I (AC,DC) E $I_{E^{\dagger}}$ IL2 VL2 (AC,DC) (-) Input IF2 (+) Input (2) 1 input V_{L1}^I (AC,DC) SOP-8 (-) Input (-/+) E l. VL2 (AC,DC) IL2 1,3. LED Anode 2,4. LED Cathode 5,6. Drain (MOS FET)

APSEMI PhotoRelays

APSEMI Photorelays are the most reliable, technically advanced logic-to-power interface devices. Their basic function is to take a low current signal from a microprocessor to control the switching of both AC and DC loads, while providing an isolation barrier between logic and power. While this function is common to all relays, Photorelays provide distinct advantages over their mechanical counterparts including:

7,8. Drain (MOS FET)

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching •
- Small package size

Immunity to EMI or RFI

Applications

These advantages make APSEI Photorelays the ideal choice for:

- Telecom/Datacom switching .
- Multiplexers •
- Meter reading systems •
- Data acquisition
- Medical equipment .
- Battery monitoring •
- I/O Sub-Systems •

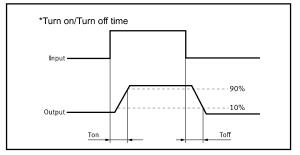
Robotics Aerospace

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- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement •
- Programmable Controllers

TPYES

| Category | Output Rating | | Paakaga | Part No. | Pooking Quantity | |
|----------|---------------|--------------|---------|----------|------------------|--|
| | Load Voltage | Load Current | Package | Part NO. | Packing Quantity | |
| AC/DC | 60V | 0.2A | SOP-8 | APW212S | 2000pcs /reel | |





Absolute Maximum Ratings (Ta = 25°C)

| Item | | Symbol | Value | Units | Note |
|---------------------------|--------------------------|------------------|------------|------------------|---------------------|
| | Continuous LED Current | F | 50 | mA | |
| Input | Peak LED Current | FP | 1000 | mA | f=100Hz, duty=1% |
| | LED Reverse Voltage | VR | 5 | V | |
| | Input Power Dissipation | Pin | 75 | mW | |
| Output | Load Voltage | VL | 60 | V(AC peak or DC) | |
| | Load Current | L | 0.2 | A | |
| | Peak Load Current | Peak | 0.5 | А | 100ms (1 pulse) |
| | Output Power Dissipation | Pout | 450 | mW | |
| Total Powe | Total Power Dissipation | | 500 | mW | |
| I/O Breakdown Voltage | | Vi/o | 2500 | Vrms | RH=60%, 1min |
| Operating Temperature | | Topr | -40 to 85 | °C | |
| Storage Temperature | | Tstg | -40 to 100 | C | |
| Pin Soldering Temperature | | T _{sol} | 260 | °C | 10 sec max. |

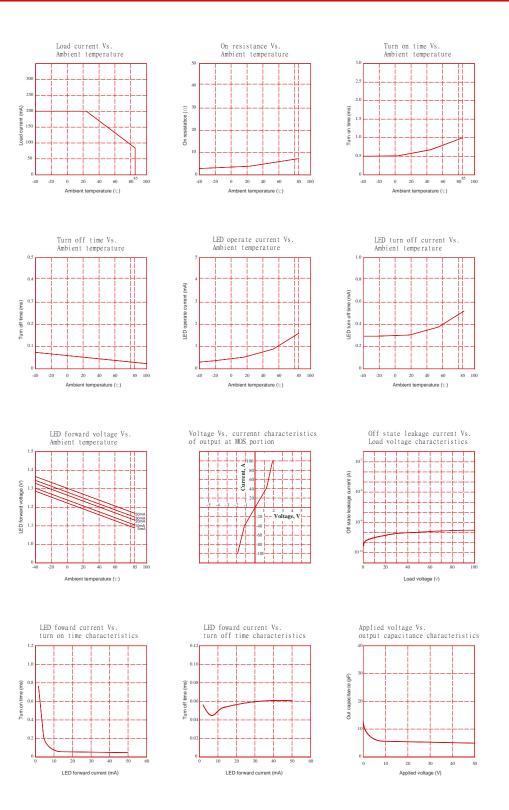
Electrical Characteristics (Ta = 25°C)

| | Item | Symbol | MIN. | TYP. | MAX. | Units | Conditions | |
|-----------|------------------------------|--------|------------------|------|------|-------|---|--|
| | LED Forward Voltage | VF | | 1.2 | 1.4 | V | l⊧=10mA | |
| Input | Operation LED Current | Fon | | 0.5 | 2.0 | mA | | |
| | Recovery LED Current | Foff | | 0.35 | 0.5 | mA | | |
| | Recovery LED Voltage | VFoff | 0.7 | | | V | | |
| Output | On-Resistance | Ron | | 2 | 8 | Ω | l⊧=5mA,l⊾=100mA, Time to flow is within 1 sec. | |
| | Off-State Leakage Current | Leak | 0.01 | 0.02 | 0.1 | uA | V₋=Rating | |
| | Output Capacitance | Cout | | 6 | | pF | V∟=0, f=1MHz | |
| Transmis | Turn-On Time | Ton | | 0.05 | 0.2 | ms | l⊧=5mA, l∟=100mA, | |
| sion | Turn-Off Time | Toff | | 0.05 | 0.5 | ms | | |
| Occurring | I/O Isolation Resistance | Ri⁄o | 10 ¹⁰ | | | Ω | DC500V | |
| Coupled | I/O Capacitance | Сі/о | | 0.8 | 1.5 | pF | f=1MHz | |

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

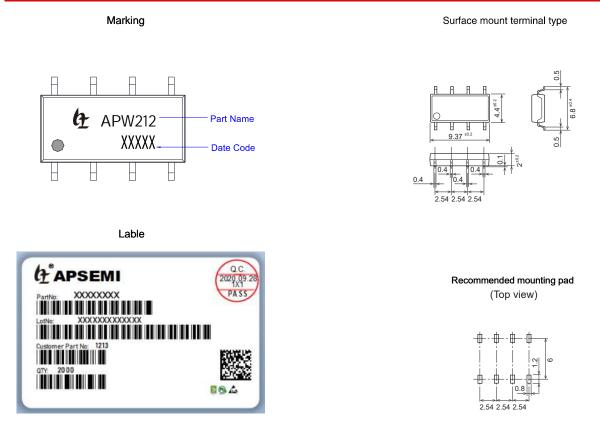


Engineering Data

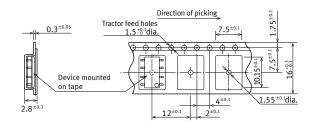




Dimensions and SOP-8 Package Unit: mm

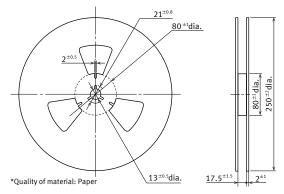


Tape dimensions (tape reel)



Tape dimensions (Unit: mm)

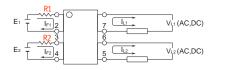
Dimensions of paper tape reel (Unit: mm)





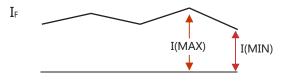
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



| E1 E2 | R1 R2(Approx) |
|-------|---------------|
| 3.3V | 300 Ω |
| 5.0V | 600 Ω |
| 12V | 1.9KΩ |
| 24V | 4.1K Ω |

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

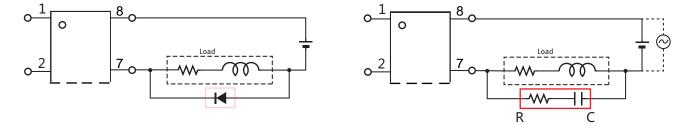
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

| Characteristic | Symbol | Min | Тур. | Max | Unit |
|-----------------|----------------|-----|------|-----|------|
| Forward current | ١ _F | 5.0 | 7.0 | 30 | mA |

Protection Circuit

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.



When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

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